

MX554BBD322M265

Ultra-Low Jitter 322.265625MHz HCSL XO

ClockWorks® FUSION

- 98fs (Integration range: 1.875MHz-20MHz)

• Industry standard 6-Pin 5mm x 3.2mm LGA

Supply Voltage (VIN).....+2.375V to +3.63V Ambient Temperature (TA)....-40°C to +85°C

LGA (T_{IA}) Still Air.....58°C/W

Features

package

• 322.265625MHz HCSL

• ± 50 ppm total frequency stability

• -40° C to $+85^{\circ}$ C temperature range

• Supports FEC line rate

• Typical phase noise:

Operating Ratings²

Junction Thermal Resistance

General Description

The MX554BBD322M265 is an ultra-low phase jitter XO with HCSL output optimized for high line rate applications.

Applications

- Optical communications
- Forward error correction (FEC) rates
- FPGA SERDES reference clock

Absolute Maximum Ratings¹

Supply Voltage (VIN)	+4.6V
Lead Temperature (soldering, 10s)	260°C
Case Temperature	115°C
Storage Temperature (T _s) ESD Machine Model	65°C to +125°C
ESD Machine Model	200V
ESD Rating (HBM)	2kV

Electrical Characteristics

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
IDD	Supply Current				95	mA
F0	Center Frequency			322.265625		MHz
	Frequency Stability	Note 4			±50	ppm
Øj	Phase Noise	Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz)		143 98		fsRMS
Tstart	Start-Up Time				10	ms
TR/TF	Rise/Fall time	20%-80%	150	300	450	ps
	Duty Cycle		48	50	52	%
VOH	Output High Voltage	HCSL output levels	660	700	850	mV
VOL	Output Low Voltage	HCSL output levels	-150	0	27	mV
VOVS	Max Output Including Overshoot				VOH + 0.3	V
VUDS	Min Output Including Undershoot		VOL - 0.3			V
VRB	Ringback Voltage		0.2			V
VOX	Absolute Crossing Point		250	350	550	mV
Vswing	Peak to Peak Output Voltage Swing		640	700	950	mV

Notes:

1. Exceeding the absolute maximum ratings may damage the device.

2. The device is not guaranteed to function outside its operating ratings.

3. Guaranteed after thermal equilibrium.

4. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

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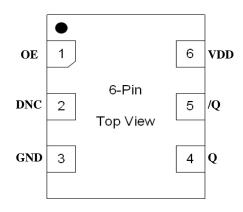
Revision 1.0 tcghelp@microchip.com

Ordering Information

Ordering Part Number	Marking Line 1	Marking Line 3	Shipping	Package
MX554BBD322M265	MX554B	BD3222	Tube	6-Pin 5mm x 3.2mm LGA
MX554BBD322M265-TR	MX554B	BD3222	Tape and Reel	6-Pin 5mm x 3.2mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

Pin Configuration

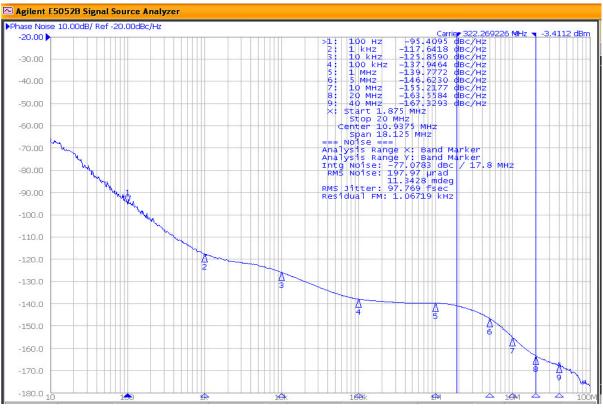


Pin Description

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	OE	I, SE	LVCMOS	Output Enable, disables output to tri-state, 0 = Disabled, 1 = Enabled, 50k Ohms Pull-Up
2	DNC			Make no connection, leave floating.
3	GND	PWR		Power Supply Ground
4, 5	Q, /Q	O, Diff	HCSL	Clock Output Frequency = 322.265625MHz
6	VDD	PWR		Power Supply

Environmental Specifications

MIL-STD-883, Method 1011, Condition A	
MIL-STD-883, Method 1004	
MIL-STD-883, Method 2002, Condition C	
MIL-STD-883, Method 2007, Condition B	
J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)	
Pb-Free / RoHS / Green Compliant	
JESD22-B102-D Method 2 (Preconditioning E)	
MIL-STD-883, Method 2004, Test Condition D	
MIL-STD-883, Method 1014, Condition C	
MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s	
MIL-STD-202, Method 215	



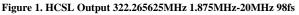
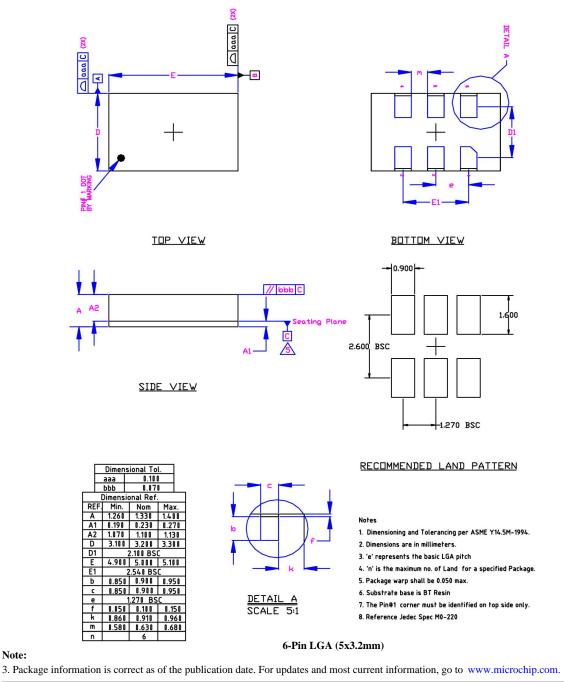




Figure 2. HCSL Output 322.265625MHz 12kHz-20MHz 143fs

Package Information and Recommended Land Pattern for 6-Pin LGA³



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Note: